UNIU40.017APC PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Tetsuo SHIMOMURA et al.

App. No : 10/598,717

Filed : September 8, 2006

For : POLISHING PAD AND

SEMICONDUCTOR DEVICE

MANUFACTURING METHOD

Examiner : Alvin J Grant

Art Unit : 3723

Conf# : 9262

CERTIFICATE OF EFS WEB TRANSMISSION

I hereby certify that this correspondence, and any other attachment noted on the automated Acknowledgement Receipt, is being transmitted from within the Pacific Time zone to the Commissioner for Patents via the EFS Web server on:

July 11, 2008 (Date)

Curtiss C. Dosier, Reg. No.46,670

AMENDMENT

Mail Stop Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed April 11th, 2008, please reconsider the present application in light of the following amendments and comments.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 9 of this paper.